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**NOTICE OF LISTING ON  
THE STOCK EXCHANGE OF HONG KONG LIMITED**



**MINMETALS LAND LIMITED**

*(Incorporated in Bermuda with limited liability)*

**(Stock Code: 230)**

**(the “Issuer”)**

**CNY400,000,000 4.60 PER CENT. CREDIT ENHANCED BONDS DUE 2025  
(THE “ADDITIONAL BONDS”)**

**(CONSOLIDATED AND FORMING A SINGLE SERIES WITH THE CNY600,000,000  
4.60 PER CENT. CREDIT ENHANCED BONDS DUE 2025 ISSUED ON 18 MARCH  
2024)  
(STOCK CODE: 84498)**

**WITH THE BENEFIT OF AN IRREVOCABLE STANDBY LETTER OF CREDIT  
ISSUED BY CHINA BOHAI BANK CO., LTD., TIANJIN BRANCH**

*Sole Global Coordinator, Joint Lead Manager and Joint Bookrunner*

**Haitong International**

*Joint Lead Managers and Joint Bookrunners*

**China Zheshang Bank Co., Ltd. (Hong Kong Branch)**

**China CITIC Bank International**

*Sole Sustainable Structuring Adviser*

**Haitong International**

Application has been made to The Stock Exchange of Hong Kong Limited for the listing of, and permission to deal in, the Additional Bonds by way of debt issues to professional investors (as defined in Chapter 37 of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited) only as described in the offering circular dated 18 April 2024. The listing of, and permission to deal in, the Additional Bonds are expected to become effective on or around 25 April 2024.

Hong Kong, 24 April 2024

*As at the date of this announcement, the board of directors of the Issuer comprises nine directors, namely Mr. He Jianbo as the chairman and an executive director, Mr. Liu Bo, Mr. Chen Xingwu and Mr. Yang Shangping as executive directors, Ms. He Xiaoli and Mr. Huang Guoping as non-executive directors, and Mr. Lam Chung Lun, Billy, Ms. Law Fan Chiu Fun, Fanny and Professor Wang Xiuli as independent non-executive directors.*